imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

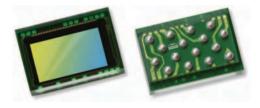
We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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OV9734-OV9234 720p HD product brief





a lead-free

package

OmniVision's Smallest 720p High Definition Sensor for Next-Generation Notebooks and Mobile Devices

The OV9734 is an ultra-compact and power efficient CameraChip[™] image sensor designed for slim notebooks, tablets, handsets, and other devices that require a thin bezel. Built on OmniVision's PureCel[®] technology, the OV9734 CameraChip[™] delivers premium quality images and video, while consuming significantly less power than previous generation image sensors.

OmniVision's 1/9-inch OV9734 is capable of capturing crisp 720p HD video at 30 frames per second (fps) or VGA video at 45 fps, while consuming approximately 25 percent less power than the previous generation 720p sensor. Additionally, the OV9734 meets the video quality specifications for popular video conferencing platforms. To fit ultra-thin bezel devices, the OV9734 comes in a compact package that can meet 2.5 mm z-height and is 47 percent smaller in y-dimension compared to the previous generation 720p sensor.

The OV9234, a black and white version of the OV9734, is also available as a dedicated IR camera solution for facial recognition and other biometric applications. Both sensors are available in CSP and COB packaging.

Find out more at www.ovt.com.





Applications

- Smartphones
- PC Multimedia
- Tablets
- **Product Features**
- support for image sizes: - full size (1280x720) - VGA (640x480)
- 2x2 RGB binning (640x360) - 2x2 B&W binning (640x360)
- support for output formats: RAW output with 1-lane MIPI
- on-chip phase lock loop (PLL)
- capable of maintaining register values at software power down
- programmable controls for: frame rate
 mirror and flip - gain/exposure
 - windowing

 support for horizontal and vertical sub-sampling

Digital Still Cameras

Toys

- automatic black level calibration (ABLC)
- defect pixel correction (DPC)
- support for black sun cancellation
- standard SCCB interface
- GPIO tri-state configurability and programmable polarity

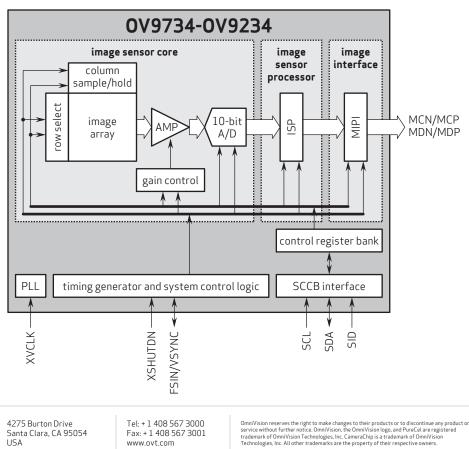
0V9734-0V9234

- OV09734-H16A-2A (color, lead-free, 16-pin CSP)
- OV09234-H16A (b&w, lead-free, 16-pin CSP)

Product Specifications

- active array size: 1280 × 720
- power supply:
 core: 1.2VDC ±5% - analog: 2.6 - 3.0V (2.8V normal) - I/O: 1.8V
- power requirements: active: 69 mW XSHUTDN: 0.9 µW
- temperature range:
 operating: -30°C to +85°C junction temperature stable image: 0°C to +50°C junction
- temperature
- output formats: 10-bit RAW RGB
- lens size: 1/9"
- lens chief ray angle: 32.1°
- input clock frequency: 6 27 MHz

- scan mode: progressive
- maximum image transfer rate: 30 fps sensitivity: 585 mV/Lux-sec
- shutter: rolling shutter
- max S/N ratio: 36.4 dB
- dynamic range: 68.4 dB @ 16x gain
- maximum exposure interval: 798 x t_{ROW}
- pixel size: 1.4 μm x 1.4 μm
- dark current: 2 e⁻/sec @ 50°C junction temperature
- image area: 1819.58 µm x 1033.34 µm
- package dimensions: 2532 μm x 1722 μm





Functional Block Diagram